



**GP**  
**ELECTRONICS**

**GP2303DT**

**30V P-Channel MOSFET**

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-30V	85m $\Omega$ @-10V	-3.4A
	125m $\Omega$ @-4.5V	

### Feature

- Trench Technology Power MOSFET
- Low  $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance

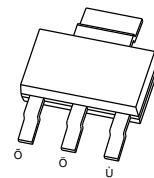
### Application

- DC/DC Converter
- Power Management

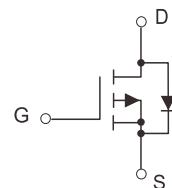
### MARKING:



**SOT-223**



**Schematic diagram**



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	$V_{DS}$	-30	V
Gate - Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1,5</sup>	$I_D$	-3.4	A
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	-12	A
Power Dissipation <sup>4,5</sup>	$P_D$	1.9	W
Thermal Resistance from Junction to Ambient <sup>5</sup>	$R_{\theta JA}$	65	$^\circ\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55~+150	$^\circ\text{C}$

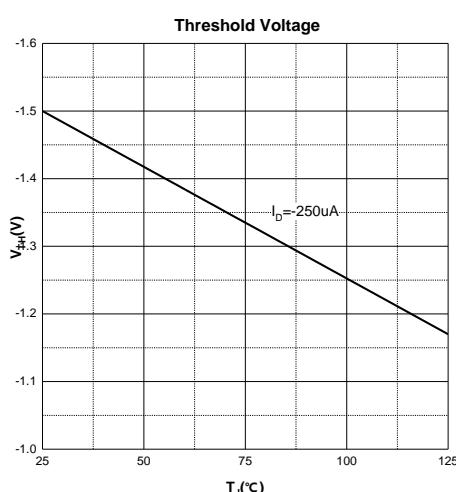
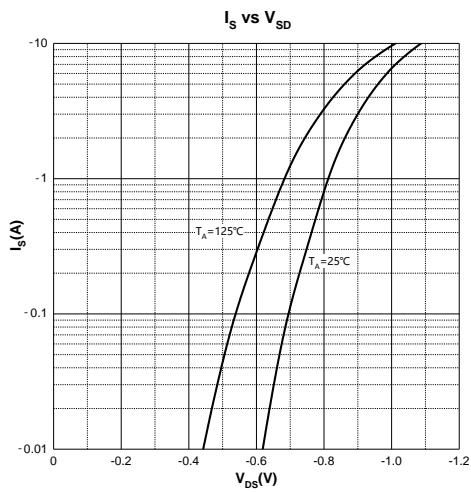
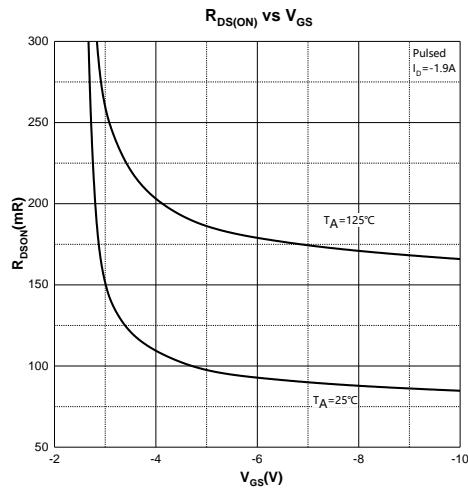
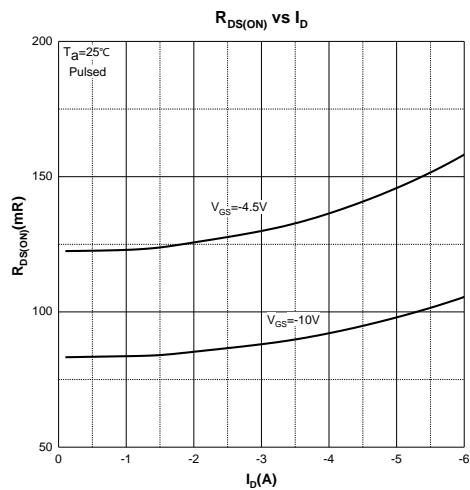
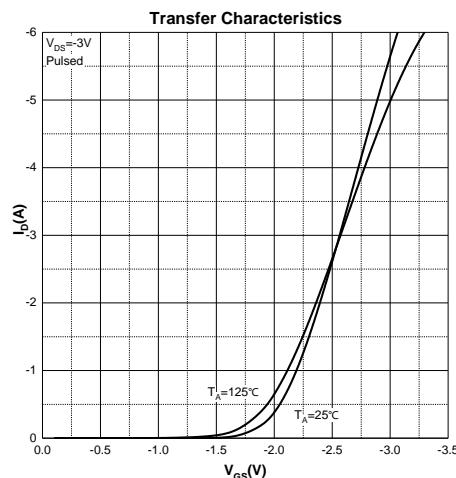
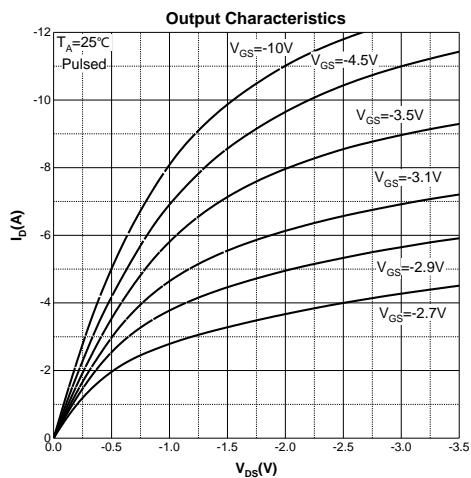
**MOSFET ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$  unless otherwise noted)**

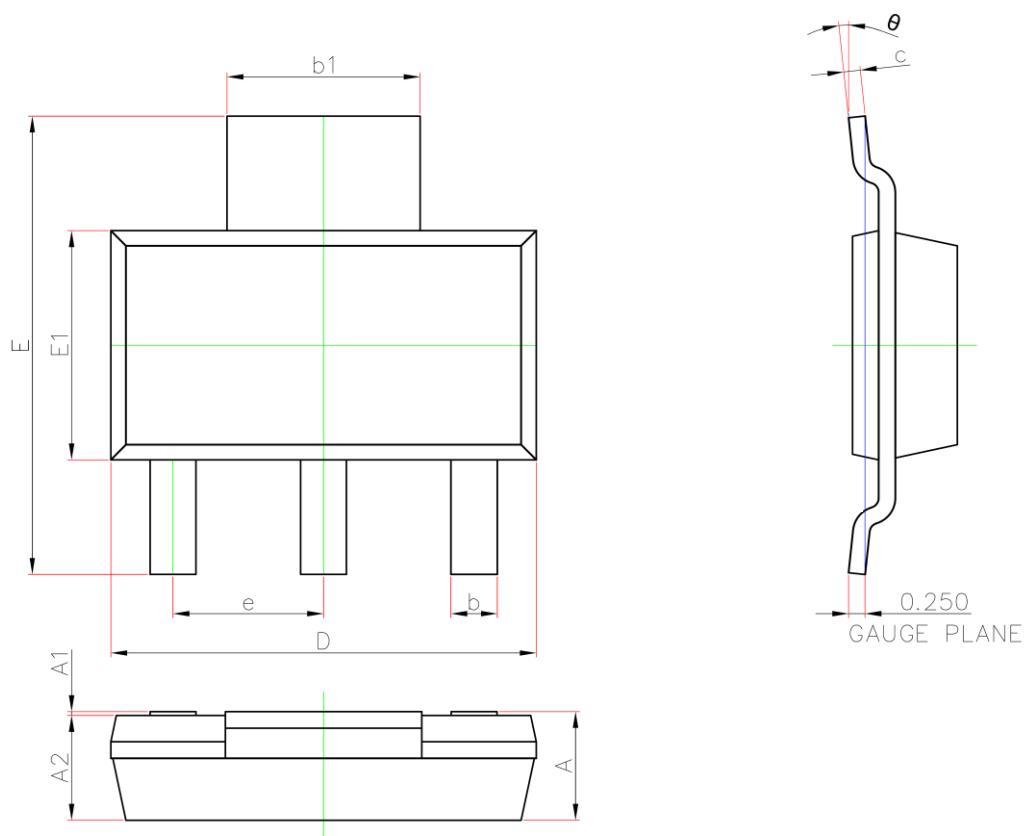
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -24\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate - Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
<b>On Characteristics<sup>3</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1	-1.5	-3.0	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -3.4\text{A}$		85	150	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -2.7\text{A}$		125	250	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = -5\text{V}, I_D = -1.9\text{A}$	2			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		266		pF
Output Capacitance	$C_{\text{oss}}$			37		
Reverse Transfer Capacitance	$C_{\text{rss}}$			25		
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, I_D = -1.9\text{A}$		5.8		nC
Gate-source Charge	$Q_{\text{gs}}$			3.2		
Gate-drain Charge	$Q_{\text{gd}}$			0.9		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, R_L = 7.5\Omega, R_G = 3\Omega$		6		ns
Turn-on Rise Time	$t_r$			4		
Turn-off Delay Time	$t_{\text{d}(\text{off})}$			15		
Turn-off Fall Time	$t_f$			6		
<b>Source - Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>3</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_s = -1.5\text{A}$			-1.2	V

Notes :

- 1.The maximum current rating is limited by Package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .
- 5.Device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Characteristics



**SOT-223 Package Information**


<b>Symbol</b>	<b>Dimensions In Millimeters</b>		<b>Dimensions In Inches</b>	
	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>
A	1.800MAX		0.071MAX	
A1	0.020	0.100	0.001	0.004
A2	1.500	1.700	0.059	0.067
b	0.600	0.840	0.024	0.033
b1	2.900	3.100	0.114	0.122
c	0.200	0.400	0.008	0.016
D	6.100	6.700	0.240	0.264
E	6.700	7.300	0.264	0.287
E1	3.300	3.700	0.130	0.146
e	2.300BSC		0.091BSC	
θ	0°	10°	0°	10°